MXD1810-MXD1813/ MXD1815-MXD1818

Low-Power µP Reset Circuits in 3-Pin SC70/SOT23

General Description

The MXD1810–MXD1813/MXD1815–MXD1818 family of microprocessor (μP) reset circuits monitor power supplies in μP and digital systems. These devices provide excellent circuit reliability and low cost by eliminating external components and adjustments when used with +2.5V/+3.0V/+3.3V (MXD1815–MXD1818), and +5V (MXD1810–MXD1813) systems.

These circuits assert a reset signal whenever the V_{CC} supply voltage declines below a preset threshold, keeping reset asserted for at least 100ms after V_{CC} rises above the reset threshold. The MXD1813/MXD1818 also keep reset asserted for at least 100ms after the output is momentarily pulled to GND by an external pushbutton switch.

The MXD1812/MXD1817 have an active-high pushpull RESET output. The MXD1810/MXD1815 (pushpull) and MXD1811/MXD1813/MXD1816/MD1818 (opendrain) have an active-low \overline{RESET} output. The open-drain devices (MXD1811/MXD1813/MXD1816/MXD1818) have an internal pullup resistor to V_{CC} . The MXD1813/MXD1818 feature a debounced manual-reset feature that asserts a reset if the \overline{RESET} pin is pulled low for more than 1.5µs. When used to initiate manual reset, \overline{RESET} debounces signals from devices such as mechanical switches. For devices with this feature, the release of the external switch triggers the reset period.

The MXD1810–MXD1813/MXD1815–MXD1818 are guaranteed to output the correct logic state for V_{CC} down to +1V. These ICs provide a reset comparator designed to ignore fast transients on V_{CC} . Reset thresholds are available between +2.18V and +4.62V. These small, low-power (4 μ A) devices are ideal for use in portable equipment. All are available in space-saving 3-pin SC70 and SOT23 packages, and are specified from -40°C to +105°C.

Applications

- Computers and Controllers
- Intelligent Instruments
- Set-Top Boxes
- Printers
- Critical µP and µC Monitoring
- Portable/Battery-Powered Equipment

Features

- Precision Monitoring of +2.5V, +3V, +3.3V, and +5V
 Power-Supply Voltages
- Available in Four Reset Output Configurations
- Factory-Set Reset Threshold Voltages: 2.18V, 2.31V, 2.55V, 2.88V, 3.06V, 4.12V, 4.37V, 4.62V
- ±2.5% Reset Threshold Accuracy Over Temperature
- Fixed Reset Timeout Period: 100ms (min)
- Guaranteed RESET/RESET Valid to V_{CC} = +1V
- Debounced Manual-Reset Detect (MXD1813/ MXD1818)
- Power-Supply Transient Immunity
- No External Components
- Low Power Consumption (4μA)
- Pin Compatible with DS181 Products (SOT23)
- 3-Pin SC70 and SOT23 Packages

Ordering Information

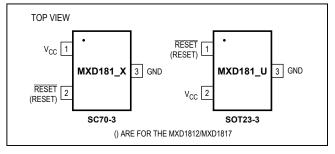
PART [†]	TEMP RANGE	PIN-PACKAGE
MXD1810URT	-40°C to +105°C	3 SOT23
MXD1810XRT	-40°C to +105°C	3 SC70

†The MXD1810–MXD1813/MXD1815–MXD1818 are available with factory-set V_{CC} reset thresholds from +2.18V to +3.06V (MXD1815–MXD1818) and +4.12V to +4.62V (MXD1810–MXD1813). Choose the desired reset-threshold suffix from the Reset Threshold Table and insert it in place of the " $_$ " following "R" in the part number. All devices are available in tape-and-reel only in 2500 unit increments. Other threshold voltages may be available. Contact factory for availability.

Devices are available in both leaded and lead(Pb)-free packaging. Specify lead-free by replacing "-T" with "+T" when ordering.

Ordering Information continued at end of data sheet.

Pin Configurations





Low-Power µP Reset Circuits in 3-Pin SC70/SOT23

Absolute Maximum Ratings

V _{CC} to GND0.3V to +6.0V	Output Current (RES
Push-Pull RESET (MXD1810/MXD1815),	Continuous Power Di
RESET (MXD1812/MXD1817) to GND0.3V to (V _{CC} + 0.3V)	3-Pin SC70 (derate
Open-Drain RESET (MXD1811/MXD1816)	3-Pin SOT23 (dera
to GND0.3V to +6.0V	Operating Temperatu
Open-Drain RESET (MXD1813/MXD1818)	Junction Temperature
to GND0.3V to (V _{CC} + 0.3V)	Storage Temperature
Input Current (V _{CC} , RESET)20mA	Lead Temperature (so

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Electrical Characteristics

 $(V_{CC} = \text{full range}, T_A = -40^{\circ}\text{C to } +105^{\circ}\text{C}, \text{ unless otherwise specified. Typical values are at } T_A = +25^{\circ}\text{C.})$ (Note 1)

PARAMETER	SYMBOL	CONI	DITIONS	MIN	TYP	MAX	UNITS
Supply Voltage Bange	\ \ \	$T_A = 0$ °C to +105°C		1.0		5.5	V
Supply Voltage Range	pply Voltage Range V _{CC}		$T_A = -40^{\circ}C \text{ to } +105^{\circ}C$			5.5]
Supply Current		$V_{CC} = +5.5V, V_{CC} > V_{T}$	_H , no load		9	16	
Supply Current	Icc	$V_{CC} = +3.6V, V_{CC} > V_{T}$	r _H , no load		4	10	μA
		MXD181R46		4.50	4.62	4.75	
		MXD181R44		4.25	4.37	4.49	
		MXD181R41		4.00	4.12	4.24]
Dood Throok old		MXD181R31		2.98	3.06	3.15	1 ,,
Reset Threshold	V _{TH}	MXD181R29		2.80	2.88	2.97	V
		MXD181R26		2.47	2.55	2.64	1
		MXD181R23		2.25	2.31	2.37	1
		MXD181 R22		2.12	2.18	2.25	
Active Reset-Timeout Period	t _{RP}	V _{CC} rising		100	150	250	ms
V to Boost Bolow	t _{RD}	$V_{CC} = (V_{TH} + 100 \text{mV})$ falling to $(V_{TH} - 200 \text{mV})$			2	5	μs
V _{CC} to Reset Delay		V _{CC} rising, t _R = 5μs		100	150	250	ms
Push-Button Detect to Reset	t _{PB}	MXD1813/MXD1818 or	ıly	1.5			μs
Push-Button Reset-Timeout Period	t _{PBRST}	MXD1813/MXD1818 or	ıly	100	150	250	ms
Input Low Voltage	V _{IL}	MXD1813/MXD1818	T _A = +25°C to +105°C			0.34	V
Input Low Voltage		only	$T_A = -40^{\circ}C \text{ to } +25^{\circ}C$			0.15]
Input High Voltage	V _{IH}	MXD1813/MXD1818 or	ıly	0.7 × V	cc		V
RESET Output Source Current	I _{OH}	V _{CC} ≥ V _{TH(MAX)} , reset MXD1810/MXD1815	not asserted,		350		μA
RESET Output Source Current	I _{OH}	V _{CC} ≥ V _{TH(MAX)} , reset asserted, MXD1812/MXD1817			350		μA
RESET Output Sink Current	I _{OL}	V _{CC} ≥ 2.7V, reset asserted, V _{OUT} = 0.4V MXD1810/MXD1811/MXD1813/MXD1815/ MXD1816/MXD1818 (Note 2)					mA
RESET Output Sink Current	l _{OL}	V _{CC} ≥ 2.7V, reset not a MXD1812/MXD1817	sserted, V _{OUT} = 0.4V	10			mA

Electrical Characteristics (continued)

 $(V_{CC} = \text{full range}, T_A = -40^{\circ}\text{C} \text{ to } +105^{\circ}\text{C}, \text{ unless otherwise specified. Typical values are at } T_A = +25^{\circ}\text{C.})$ (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	V _{OH}	0 < I _{OH} < 500μA	V _{CC} - 0.5	V _{CC} - 0.1		V
Output Capacitance (Note 2)	C _{OUT}				10	pF
Internal Pullup Resistor,	D-	MXD1811/MXD1816	3.5	5.5	7.5	kΩ
Open-Drain	R _P	MXD1813/MXD1818	3.1	5.5	7.5	K77

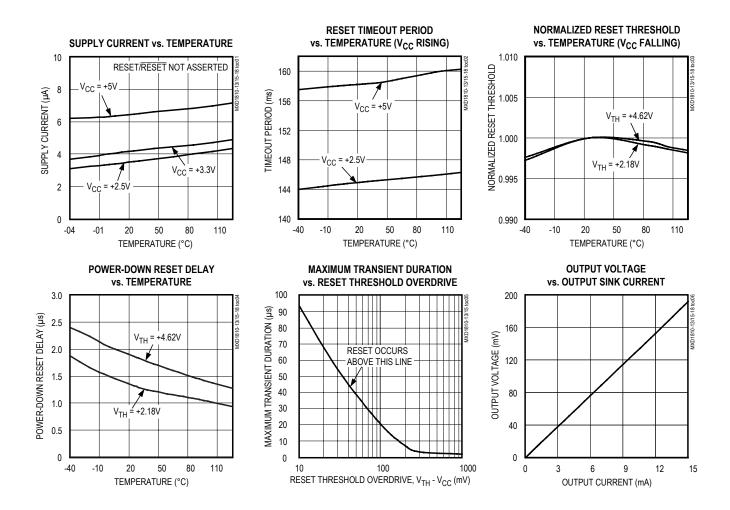
Note 1: Production testing done at T_A = +25°C; limits over temperature guaranteed by design.

Note 2: The MXD1811/MXD1813/MXD1816/MXD1818 have an internal pullup resistor which may deliver 1mA of sink current.

Note 3: Guaranteed by design.

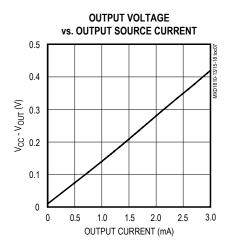
Typical Operating Characteristics

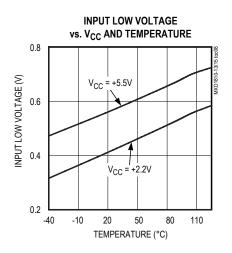
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$



Typical Operating Characteristics (continued)

(TA = +25°C, unless otherwise noted.)





Pin Descriptions

MXD1810/MXD1815

PI	N	NAME	FUNCTION
SC70	SOT23	IVAIVIL	TONCTION
2	1	RESET	Push-Pull, Active-Low Reset Output. \overline{RESET} changes from high to low when V_{CC} drops below the selected reset threshold. \overline{RESET} remains low for the reset timeout period after V_{CC} exceeds the device reset threshold.
1	2	V_{CC}	Supply Voltage and Input for Reset-Threshold Monitor
3	3	GND	Ground

MXD1811/MXD1816

PI	N	NAME	FUNCTION
SC70	SOT23	T23 PUNCTION	
2	1	RESET	Open-Drain, Active-Low Reset Output. \overline{RESET} changes from high to low when V_{CC} drops below the selected reset threshold. \overline{RESET} remains low for the reset timeout period after V_{CC} exceeds the device reset threshold. \overline{RESET} has an internal $5.5k\Omega$ pullup resistor.
1	2	V _{CC}	Supply Voltage and Input for Reset-Threshold Monitor
3	3	GND	Ground

Pin Description (continued)

MXD1812/MXD1817

PI	IN	NAME	FUNCTION	
SC70	SOT23	INAIVIE	FUNCTION	
2	1	RESET	Push-Pull, Active-High Reset Output. RESET changes from low to high when V_{CC} drops below the selected reset threshold. RESET remains high for the reset timeout period after V_{CC} exceeds the device reset threshold.	
1	2	V_{CC}	Supply Voltage and Input for Reset-Threshold Monitor	
3	3	GND	Ground	

MXD1813/MXD1818

PI	PIN		FUNCTION		
SC70	SOT23	NAME	FUNCTION		
2	1	RESET	Open-Drain, Active-Low Reset Output with Manual Reset Detect. $\overline{\text{RESET}}$ changes from high to low when V _{CC} drops below the selected reset threshold, or $\overline{\text{RESET}}$ is externally pulled low for at least 1.5µs. $\overline{\text{RESET}}$ remains low for the reset timeout period after V _{CC} exceeds the device reset threshold or after the external manual reset is released. $\overline{\text{RESET}}$ has an internal 5.5k Ω pullup resistor.		
1	2	V _{CC}	Supply Voltage and Input for Reset-Threshold Monitor		
3	3	GND	Ground		

Detailed Description

RESET/RESET Output

A microprocessor's (μ P's) reset input starts the microprocessor in a known state. The MXD1810–MXD1813/MXD1815–MXD1818 μ P supervisory circuits assert reset to prevent code-execution errors during power-up, power-down, and brownout conditions (Figure 4). Whenever V_{CC} falls below the reset threshold, the reset output asserts. Once V_{CC} exceeds the reset threshold, an internal timer keeps the reset output asserted for the specified reset timeout period (t_{RP}). Reset is also triggered by an externally initiated rising edge on the RESET pin (MXD1813/MXD1818), following a low signal of 1.5 μ s minimum duration.

Push-Button Reset (MXD1813/MXD1818)

Many μP -based products require push-button reset capability (Figure 5), allowing the operator, a test technician, or external logic circuitry to initiate reset. On the MXD1813/MXD1818, a logic-low on \overline{RESET} held for greater than 1.5 μ s asserts a reset. \overline{RESET} deasserts following a 100ms minimum reset timeout

delay (t_{PBRST}). A manual-reset input shorter than 1.5 μ s may release RESET without the 100ms minimum reset timeout delay. To facilitate use with mechanical switches, the MXD1813/MXD1818 contain internal debouncing circuitry. A debounced waveform is shown in Figure 6.

Applications Information

Interfacing to µPs with Bidirectional Reset Pins

Since the \overline{RESET} output on the MXD1811/MXD1816 is open drain, these devices interface easily with μPs that have bidirectional reset pins, such as the Motorola 68HC11. Connecting the μP supervisor's \overline{RESET} output directly to the microcontroller's (μC 's) \overline{RESET} pin allows either device to assert reset (Figure 7). No external pullup resistor is required, as it is contained within the MXD1811/MXD1816.

Negative-Going Vcc Transients

In addition to issuing a reset to the μP during power-up, power-down, and brownout conditions, these devices are relatively immune to short-duration, negative-going V_{CC} transients (glitches).

Functional Diagram

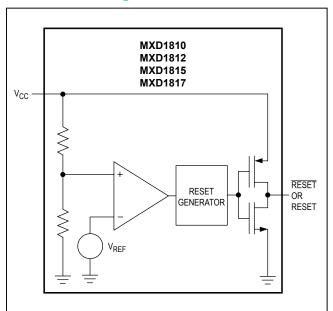


Figure 1. Functional Diagram, Push-Pull Output

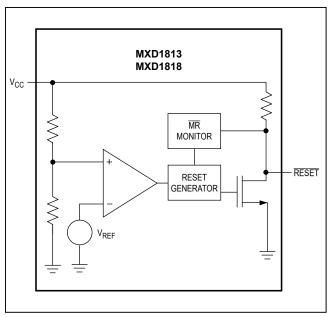


Figure 3. Functional Diagram, Open-Drain Active-Low Output with Manual Reset Detection

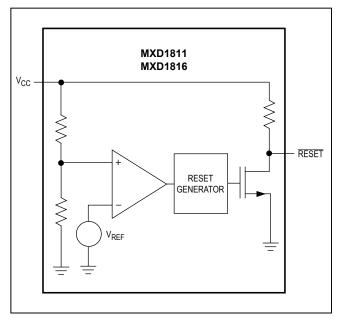
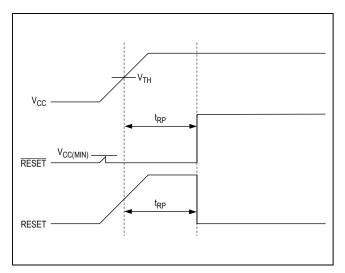


Figure 2. Functional Diagram, Open-Drain Active-Low Output

The *Typical Operating Characteristics* show the Maximum Transient Duration vs. Reset Threshold Overdrive for which reset pulses are **not** generated. The graph shows the maximum pulse width that a negative-going V_{CC} transient may typically have without issuing a reset signal. As the amplitude of the transient increases, the maximum allowable pulse width decreases.

Ensuring a Valid Reset Output Down to V_{CC} = 0

When V_{CC} falls below the minimum operating voltage, push-pull-structured reset sinking (or sourcing) capabilities decrease dramatically. High-impedance CMOSlogic inputs connected to the RESET/RESET pin can drift to indeterminate voltages. This does not present a problem in most cases, since most μ Ps and circuitry do not operate at V_{CC} below +1V. For MXD1810/MXD1815 applications where RESET must be valid down to V_{CC} = 0, adding a pulldown resistor between RESET and GND removes stray leakage currents, holding RESET low (Figure 8). The pulldown resistor value is not critical; $100 \text{k}\Omega$ is large enough not to load RESET and small enough to pull RESET low. For MXD1812/ MXD1817 applications where



MXD1813
MXD1818

RESET

RESET

MANUAL
RESET

Figure 4. Power-Up Reset Timing Diagram

Figure 5. Push-Button Manual Reset

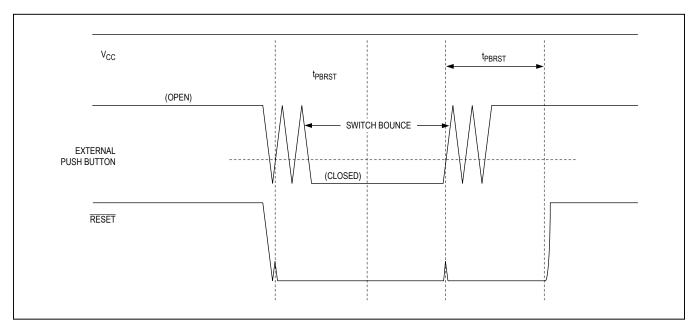


Figure 6. Manual Reset Timing Diagram

RESET must be valid to V_{CC} = 0, a 100k Ω pullup resistor between RESET and V_{CC} holds RESET high when V_{CC} falls below the minimum operating voltage (Figure 9).

The MXD1811/MXD1813/MXD1816/MXD1818 have open-drain, active-low outputs with a pullup resistor included internal to the devices. While using these devices, RESET will most likely not maintain an active

condition when the supply voltage drops below the minimum V_{CC} , but will drift to a nonactive level due to the pullup resistor and the reduced sinking capability of the open-drain output. Therefore, these devices are not recommended for applications where the $\overline{\text{RESET}}$ pin is required to be valid at V_{CC} = 0.

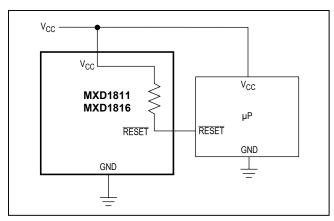


Figure 7. Interfacing to Microprocessors with Bidirectional Reset Pins

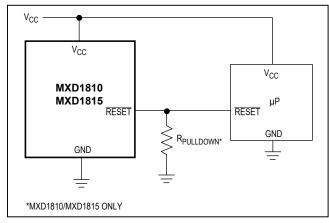


Figure 8. Ensuring Valid \overline{RESET} Output Down to V_{CC} = 0 (MXD1810/MXD1815 only)

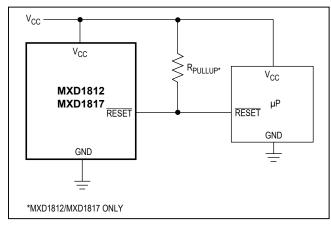


Figure 9. Ensuring Valid RESET Output Down to $V_{CC} = 0$ (MXD1812/MXD1817 only)

Table 1. Device Marking Codes

DART	ТОР	MARK
PART	SOT23	SC70
MXD1810_R46	FZIV	AEK
MXD1810_R44	FZKD	AHU
MXD1810_R41	FZKC	AHT
MXD1811 _R46	FZKF	AHW
MXD1811_R44	FZIW	AEL
MXD1811_R41	FZKE	AHV
MXD1812_R46	FZKH	AHY
MXD1812_R44	FZKG	AHX
MXD1812_R41	FZIX	AEM
MXD1813_R46	FZIY	AEN
MXD1813_R44	FZKJ	AIA
MXD1813_R41	FZKI	AHZ
MXD1815 _R31	FZKN	AIE
MXD1815_R29	FZIZ	AEO
MXD1815_R26	FZKM	AID
MXD1815_R23	FZKL	AIC
MXD1815_R22	FZKK	AIB
MXD1816 _R31	FZKR	All
MXD1816_R29	FZKQ	AIH
MXD1816_R26	FZKP	AIG
MXD1816_R23	FZKO	AIF
MXD1816_R22	FZJA	AEP
MXD1817_R31	FZJB	AEQ
MXD1817_R29	FZKV	AIM
MXD1817_R26	FZKU	AIL
MXD1817_R23	FZKT	AIK
MXD1817_R22	FZKS	AIJ
MXD1818 _R31	FZKY	AIP
MXD1818_R29	FZKX	AIO
MXD1818_R26	FZJC	AER
MXD1818_R23	FZKW	AIN
MXD1818_R22	FZJE	AEV

Selector Guide

PART	5V SYSTEMS	2.5V/3.0V/3.3V SYSTEMS	PUSH-PULL RESET	OPEN-DRAIN RESET	PUSH-PULL RESET	OPEN-DRAIN RESET WITH PUSHBUTTON DETECT
MXD1810	V	_	~	_	_	_
MXD1811	✓	_	_	'	_	_
MXD1812	'	_	_	_	~	_
MXD1813	·	_	_	_	_	V
MXD1815	_	~	~	_	_	_
MXD1816	_	~	_	~	_	_
MXD1817	_	~	_	_	V	_
MXD1818	_	~	_	_	_	V

Ordering Information (continued)

PART [†]	TEMP RANGE	PIN-PACKAGE
MXD1811 URT	-40°C to +105°C	3 SOT23
MXD1811XRT	-40°C to +105°C	3 SC70
MXD1812URT	-40°C to +105°C	3 SOT23
MXD1812XRT	-40°C to +105°C	3 SC70
MXD1813URT	-40°C to +105°C	3 SOT23
MXD1813XRT	-40°C to +105°C	3 SC70
MXD1815URT	-40°C to +105°C	3 SOT23
MXD1815XRT	-40°C to +105°C	3 SC70
MXD1816URT	-40°C to +105°C	3 SOT23
MXD1816XRT	-40°C to +105°C	3 SC70
MXD1817 URT	-40°C to +105°C	3 SOT23
MXD1817XRT	-40°C to +105°C	3 SC70
MXD1818URT	-40°C to +105°C	3 SOT23
MXD1818XRT	-40°C to +105°C	3 SC70

 \dagger The MXD1810–MXD1813/MXD1815–MXD1818 are available with factory-set V_{CC} reset thresholds from +2.18V to +3.06V (MXD1815–MXD1818) and +4.12V to +4.62V (MXD1810–MXD1813). Choose the desired reset-threshold suffix from the Reset Threshold Table and insert it in place of the "__" following "R" in the part number. All devices are available in tape-and-reel only in 2500 unit increments. Other threshold voltages may be available. Contact factory for availability.

Devices are available in both leaded and lead(Pb)-free packaging. Specify lead-free by replacing "-T" with "+T" when ordering.

Reset Threshold Table

PART	SUFFIX ()	TYP. RESET THRESHOLD (V)*
MXD1810-MXD1813	46	4.62
MXD1810-MXD1813	44	4.37
MXD1810-MXD1813	41	4.12
MXD1815-MXD1818	31	3.06
MXD1815-MXD1818	29	2.88
MXD1815-MXD1818	26	2.55
MXD1815-MXD1818	23	2.31
MXD1815-MXD1818	22	2.18

^{*}Factory-trimmed reset thresholds are nominally ±1.5% at room temperature.

Chip Information

PROCESS TECHNOLOGY: BICMOS

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
3 SC70	X3-2	21-0075	90-0208
3 SOT23	U3-1	21-0051	90-0179

MXD1810-MXD1813/ MXD1815-MXD1818

Low-Power µP Reset Circuits in 3-Pin SC70/SOT23

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
1	12/05	Miscellaneous updates	1,9–11
2	No /V OPN in <i>Ordering Information</i> , removed automotive reference from <i>Applications</i> section; updated <i>Packaging Information</i>		1, 10, 11

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

Maxim Integrated cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim Integrated product. No circuit patent licenses are implied. Maxim Integrated reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.